

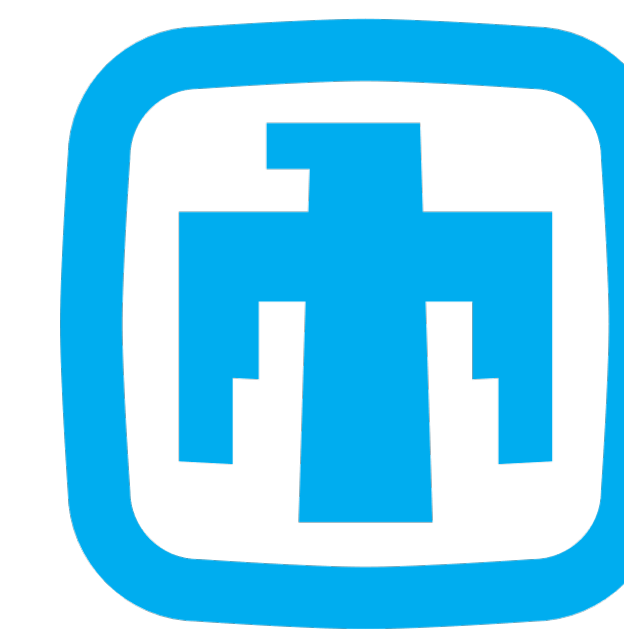
# Assembling semiconductor twistronic superlattices through dry transfer printing of single-crystalline semiconductor nanomembranes derived from bulk wafers

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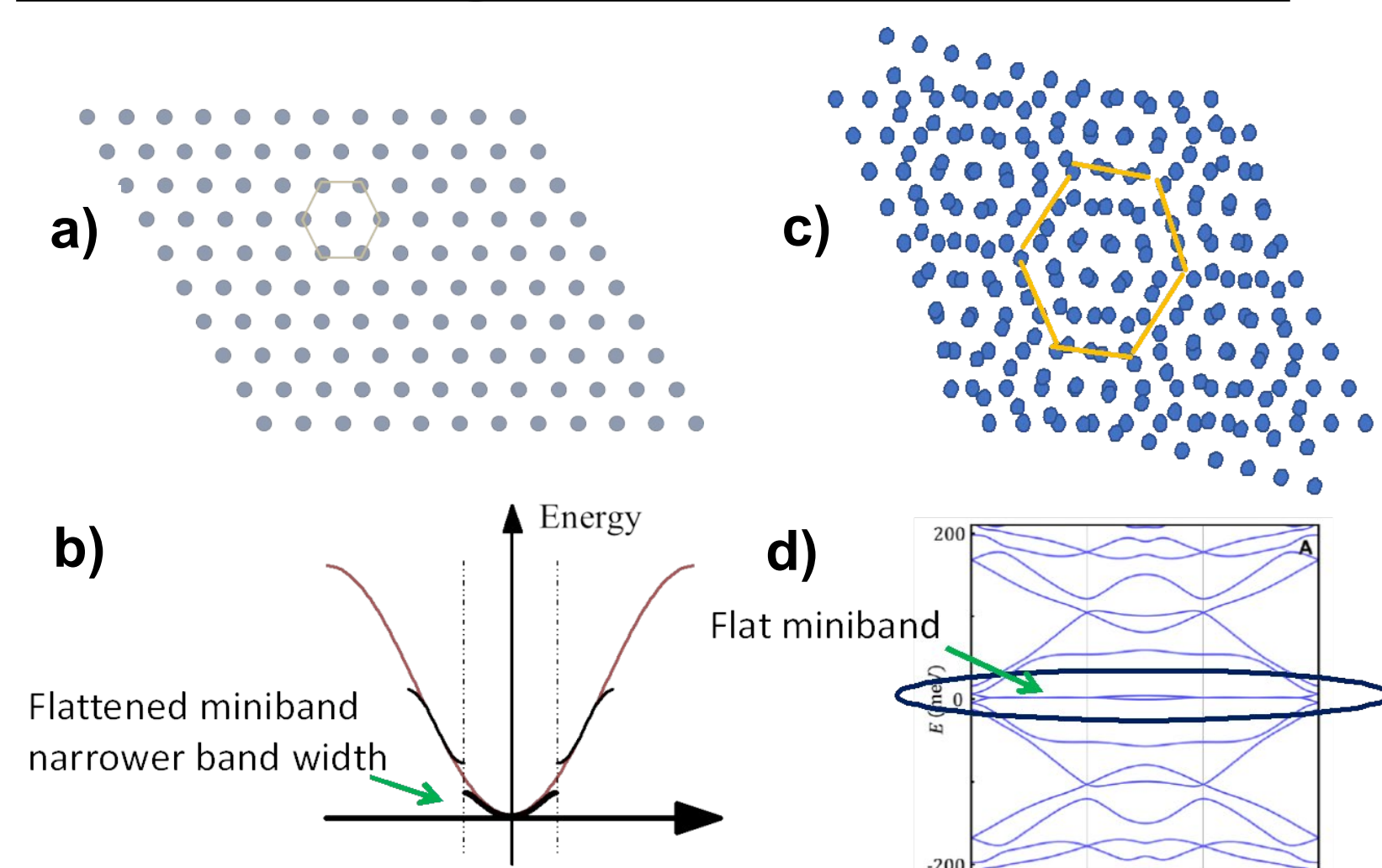
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## ABSTRACT

Our goal is to develop a wafer-scale transfer technique that enables: 1) twistronics made of dissimilar single-crystalline semiconductor bilayers that are difficult to grow by Molecular-beam epitaxy (MBE) method; 2) semiconductor twistronic superlattice structures that are beyond the epoxy bond and stop-etch (EBASE) capability. Our approach will create a new way to form twistronic structures far beyond current approaches and allow us to explore more exotic quantum phenomena.

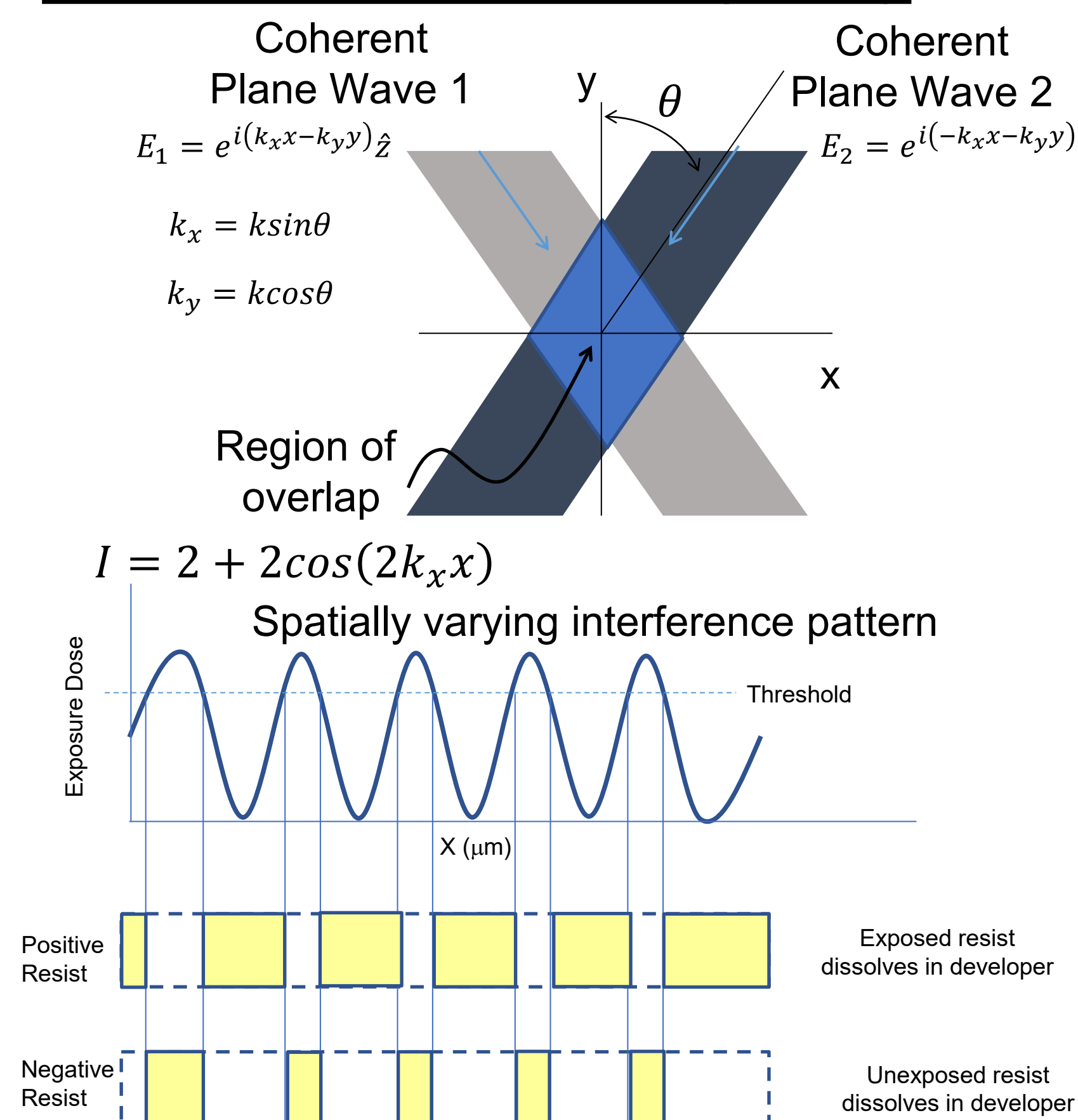
## I. INTRODUCTION

### a. Artificial graphene-Twistronics

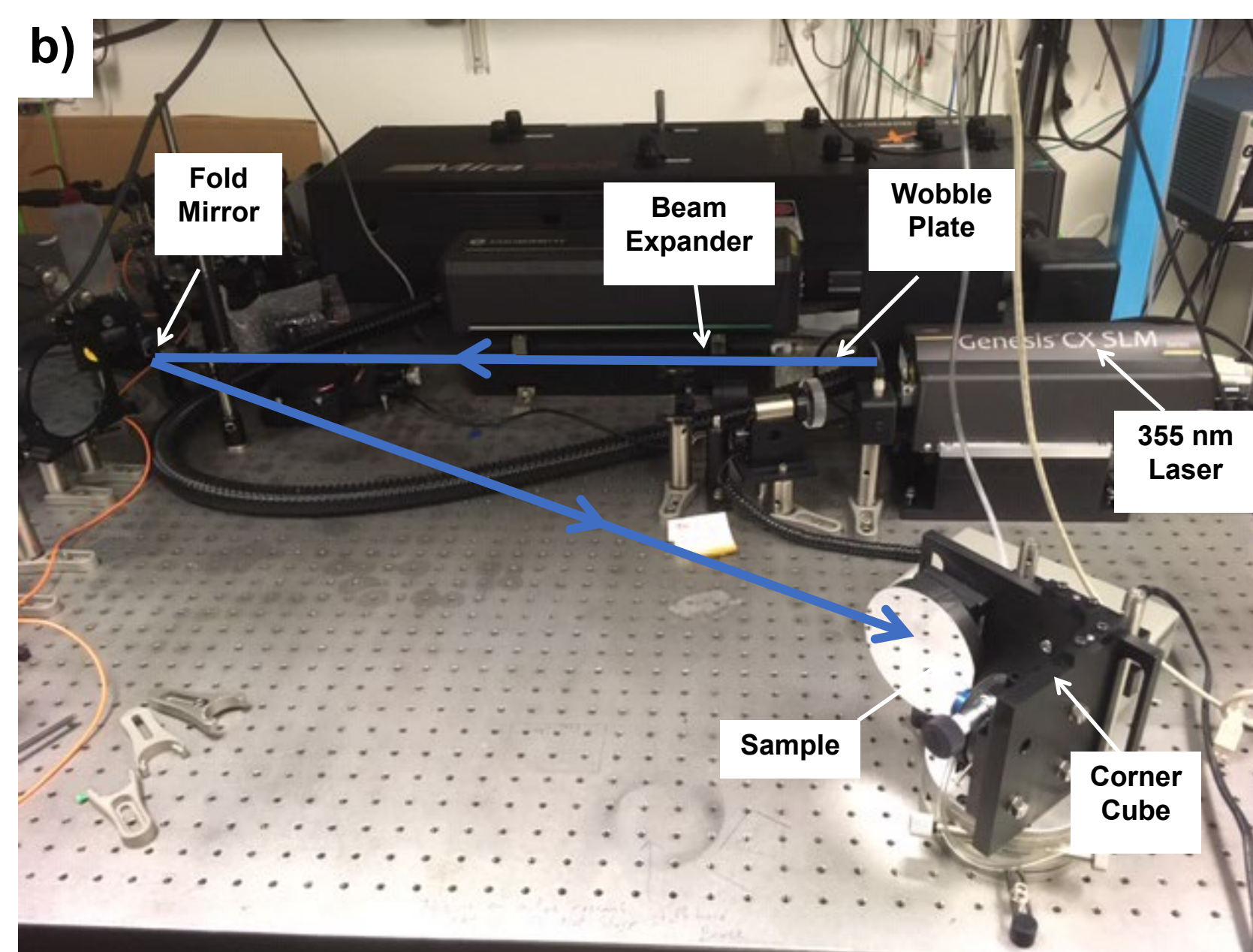
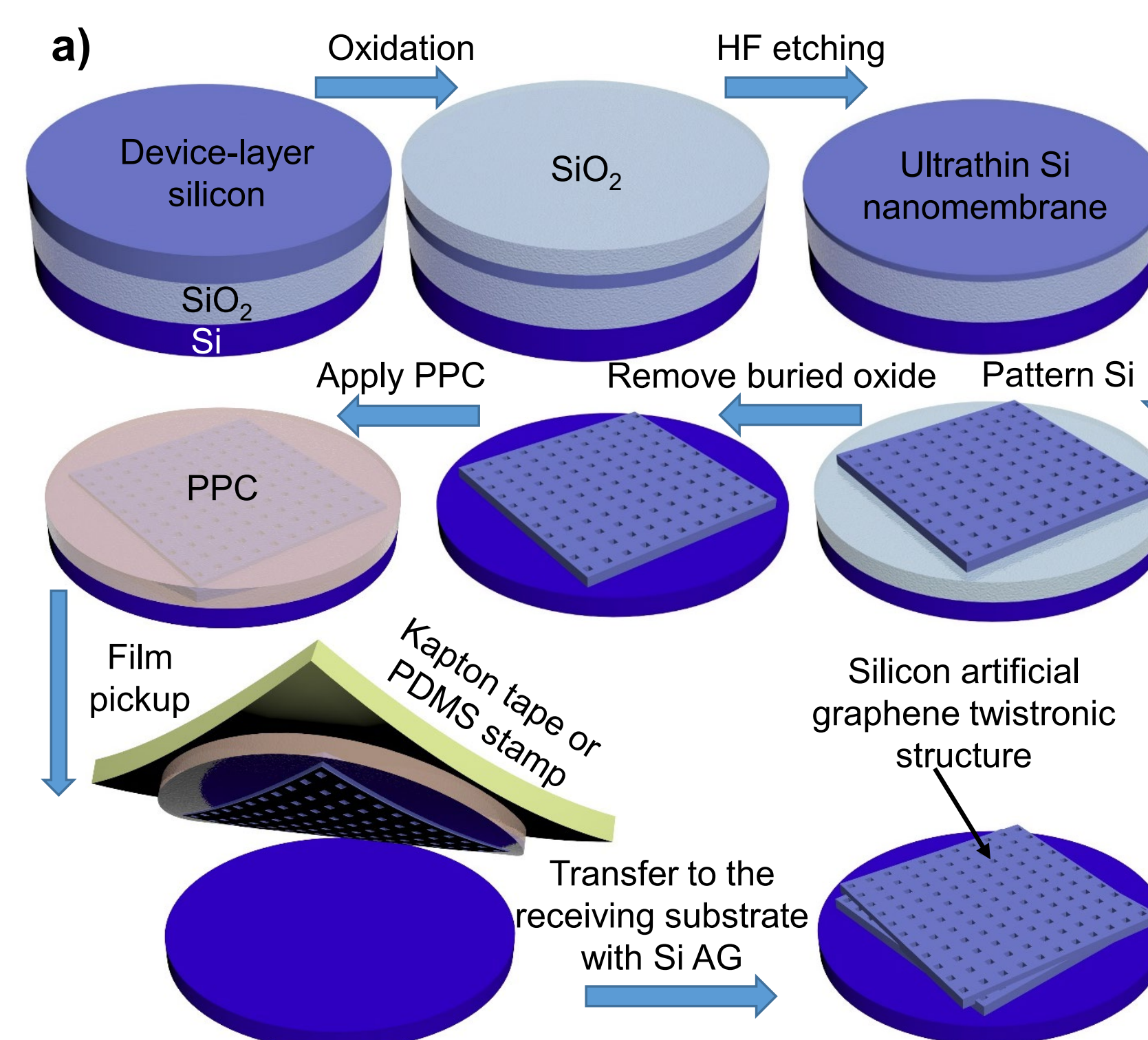


(a) Schematic representation of artificial graphene (AG). The blue dots form a honeycomb structure, as indicated by the yellow lines. (b) Formation of flattened mini-band with a narrow band width. (c) Twisted bilayer AG with a twist angle of 15°. (d) Expected flat miniband formation in twisted bilayer AG.

### b. Interferometric Lithography



## II. EXPERIMENT



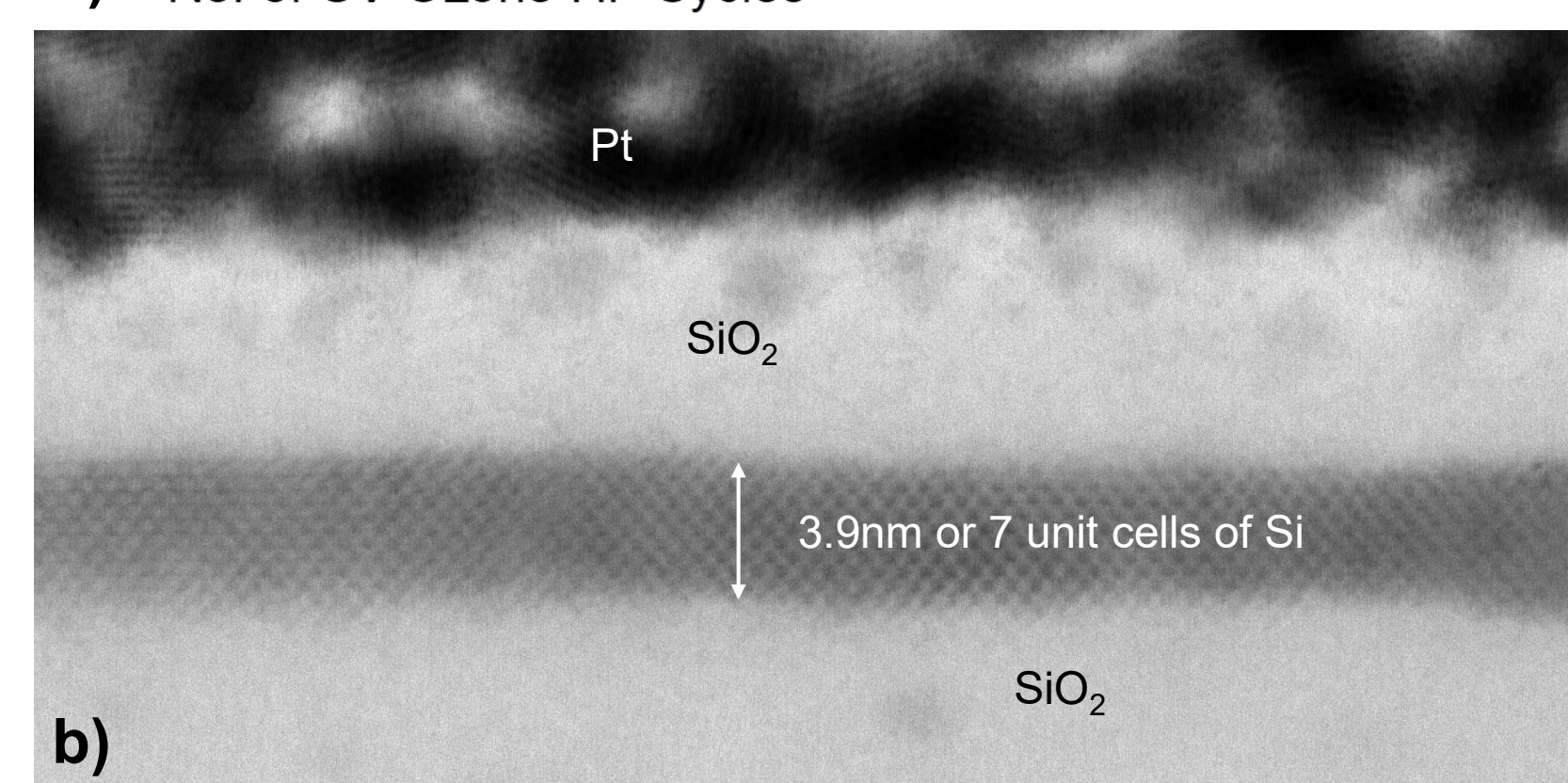
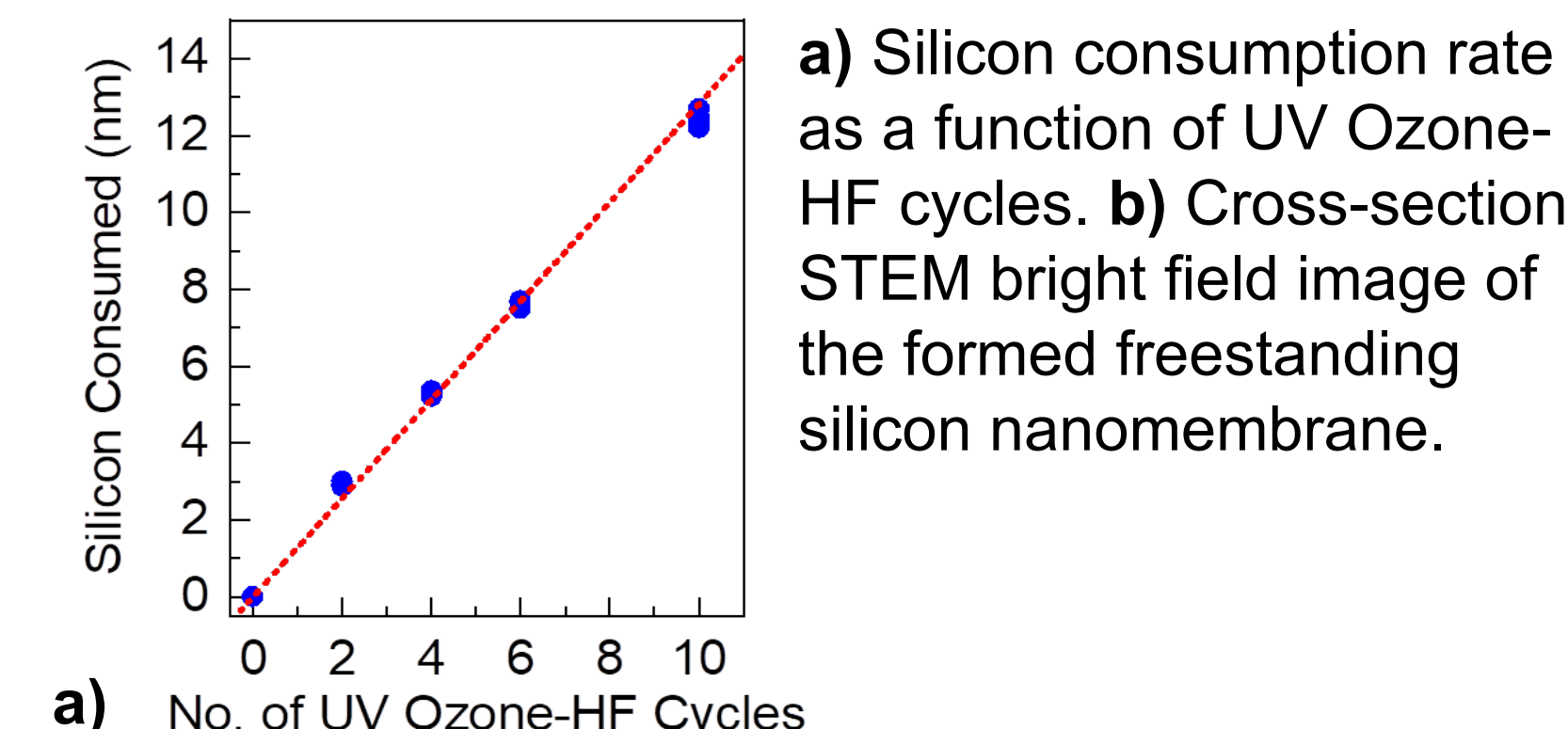
Schematic of (a) the transfer printing process to fabricate twistronics superlattice and (b) the simple Lloyd's Mirror setup utilized in interferometric lithography.

### Acknowledgement:

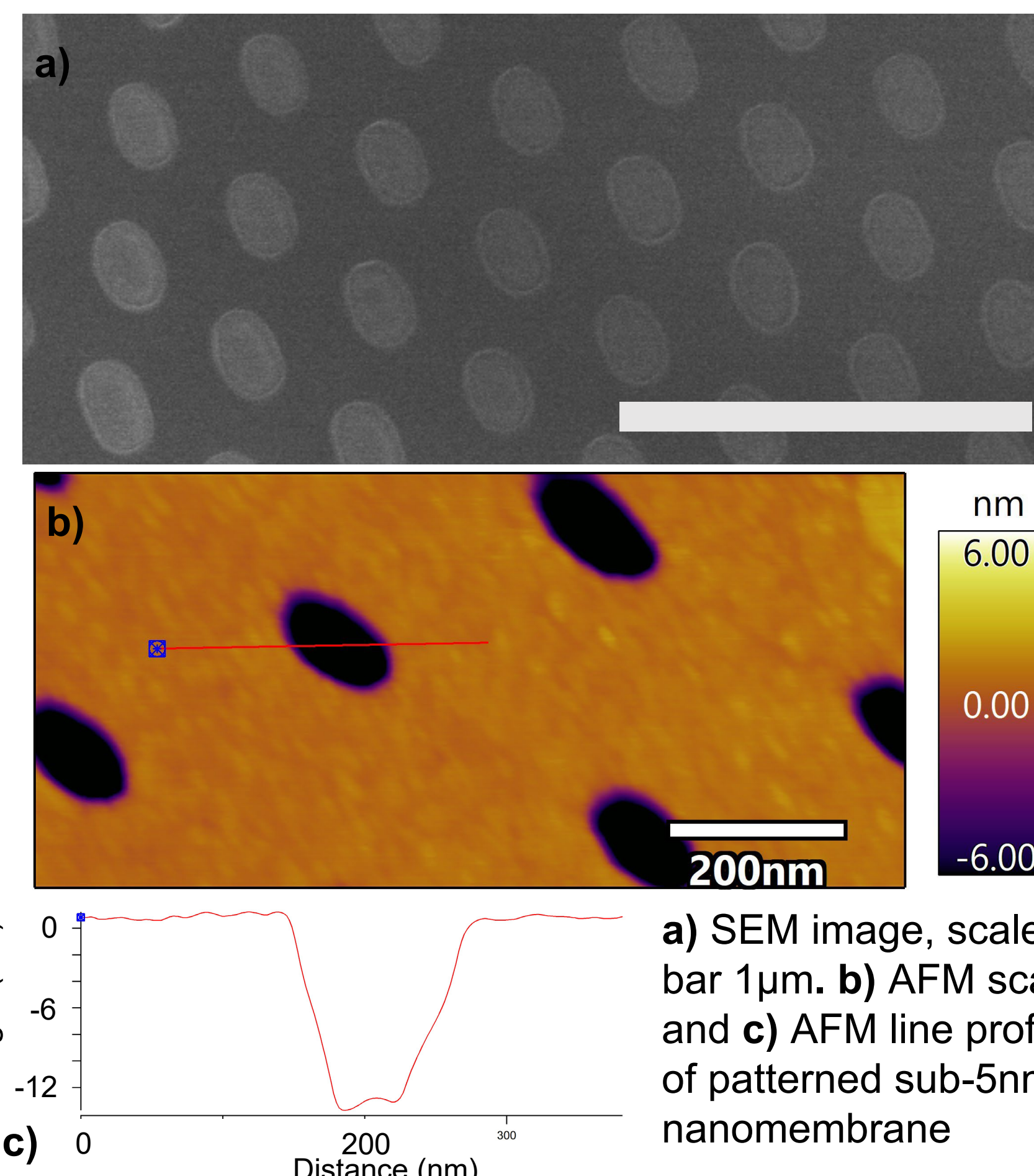
This work was funded by Sandia National Laboratories under the Sandia Academic Alliance Partnerships.

## III. RESULTS

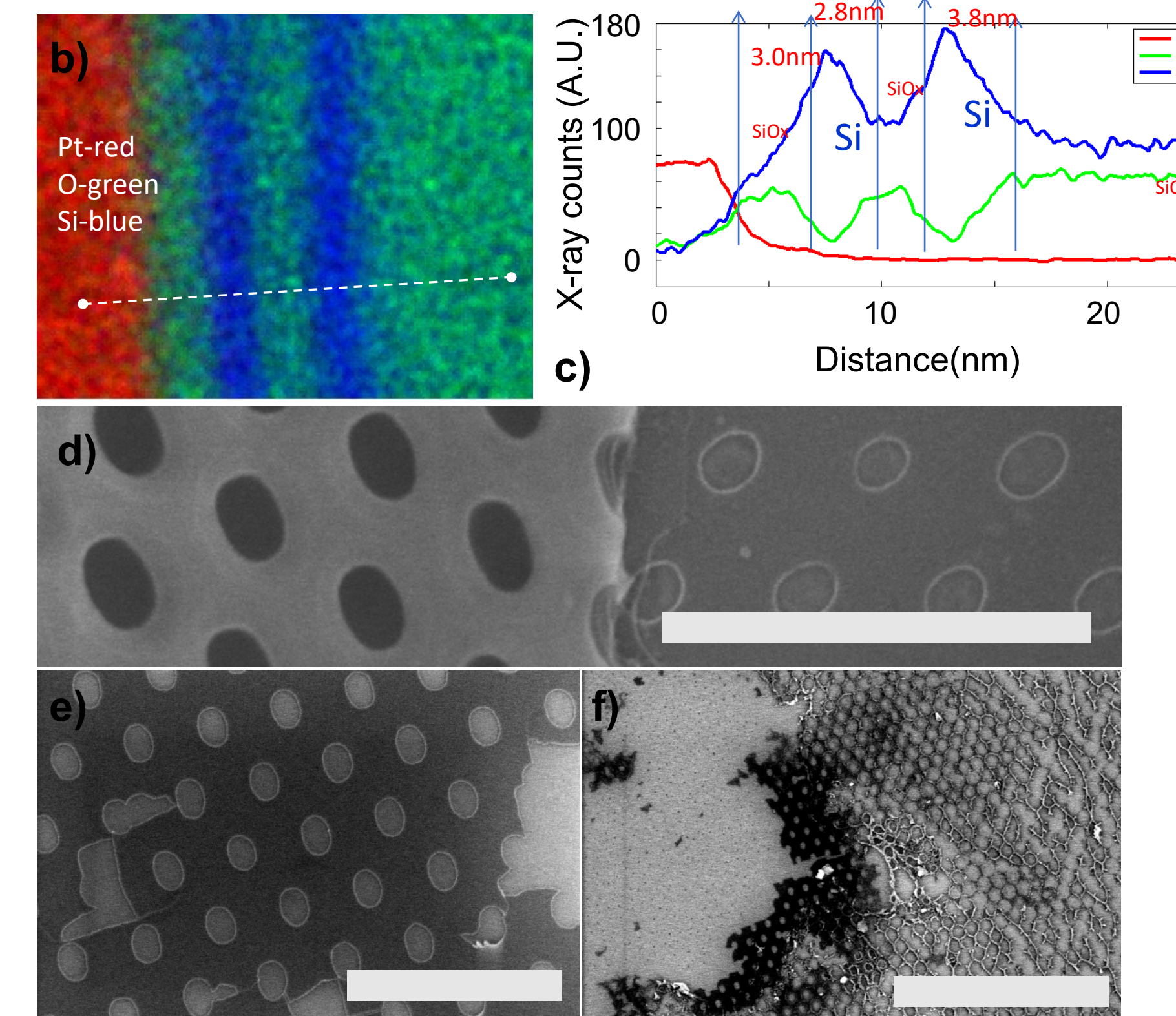
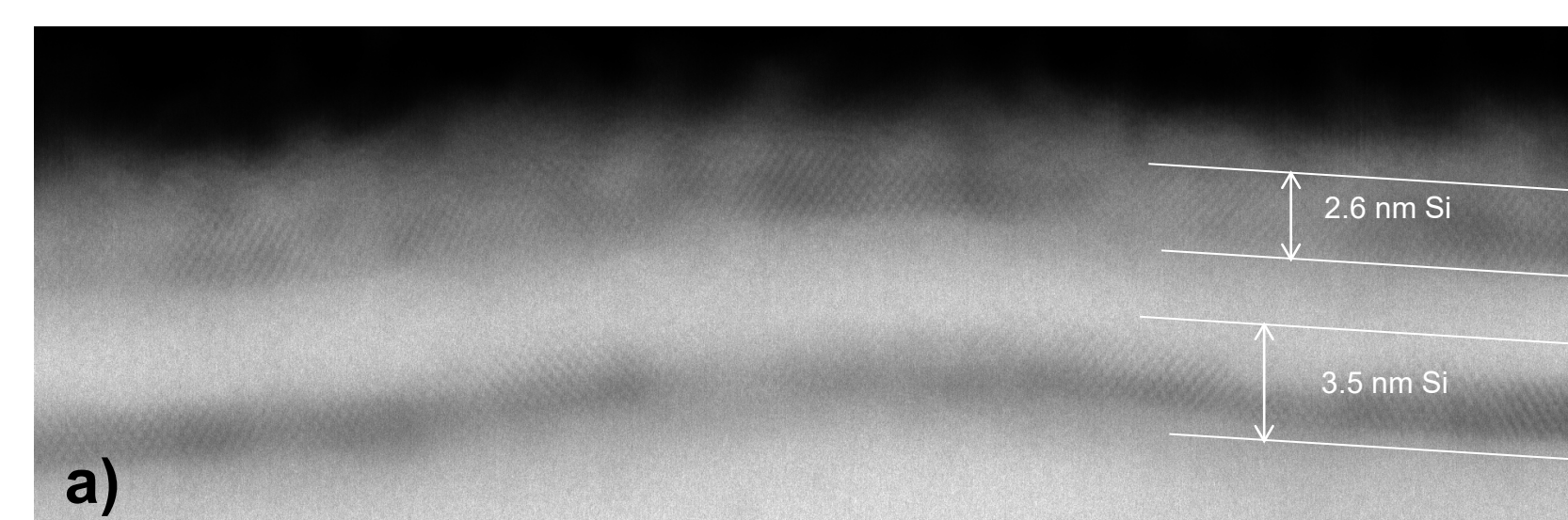
### a. Ultrathin-single crystalline Si nanomembrane



### b. Patterning Si nanomembrane

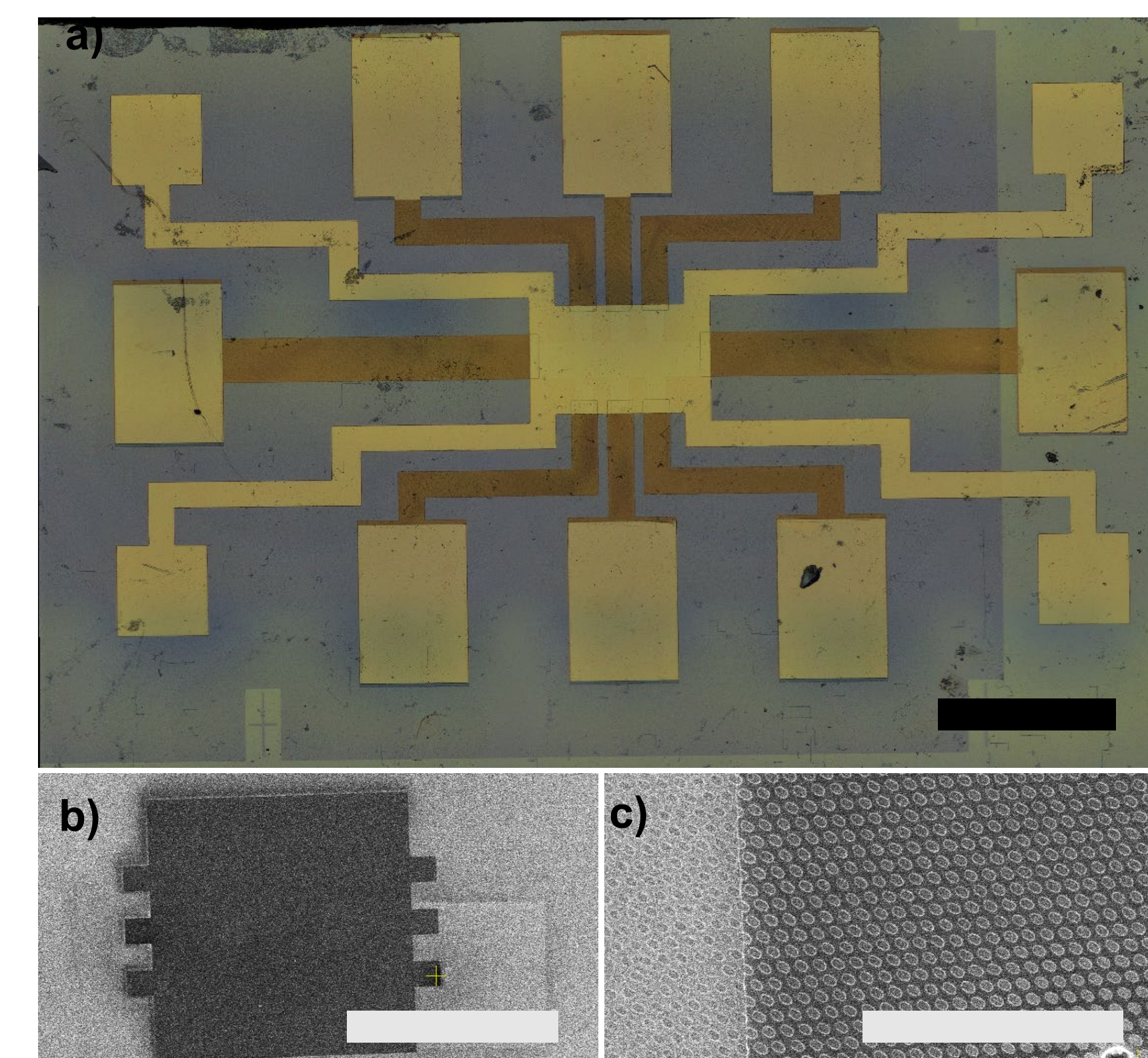


### c. Transfer of nanomembrane



(a) Cross-section TEM, (b) EDS mapping and (c) EDS line profile of transferred Si nanomembrane on Si nanomembrane. SEM image of (d) 90° twisted-bilayer Si nanomembrane before cleaning (scale bar 1 μm), (e) transferred nanomembrane on SiO<sub>2</sub> after cleaning at 50,000 magnification (scale bar 1 μm) and (f) 10,000 magnification (scale bar 5 μm).

### d. Hall-bar structure



(a) Optical image of the hall-bar structure (scale bar 500 μm). SEM image of the patterned Si channel (b) 100 magnification (scale bar 400 μm) (c) 10,000 magnification (scale bar 5 μm).

## IV. FUTURE

- ❖ Refine transfer process to improve the transfer yield.
- ❖ Characterize the unique electrical and optical properties of generated artificial graphene.
- ❖ Fabricate the twistronic device structures and characterize their novel quantum phenomena.